

Surface Mount Ultrafast Power Rectifier

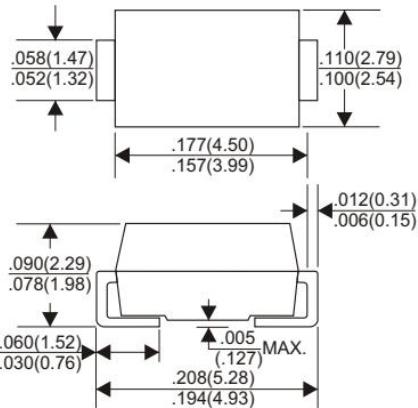
FEATURES

- * Ideal for surface mount applications
- * Easy pick and place
- * Built-in strain relief
- * Low forward voltage drop

MECHANICAL DATA

- * Case: Molded plastic
- * Epoxy: UL 94V-0 rate flame retardant
- * Metallurgically bonded construction
- * Polarity: Color band denotes cathode end
- * Mounting position: Any
- * Weight: 0.063 grams

DO-214AC(SMA)



Dimensions in inches and (millimeters)



MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
ES2J	SMA (Pb-Free)	2000 / Tape & Reel

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	600	V
Average Rectified Forward Current @ $T_L = 145^\circ C$ @ $T_L = 110^\circ C$	$I_{F(AV)}$	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I_{FSM}	30	A
Operating Junction Temperature Range	T_J	-65 to +175	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Lead ($T_L = 25^\circ C$) (Note 1)	Ψ_{JL} (Note 2)	24	°C/W
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	216	

ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3) ($i_F = 1.0 A$, $T_J = 25^\circ C$) ($i_F = 1.0 A$, $T_J = 150^\circ C$)	v_F	1.25 1.05	V
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^\circ C$) (Rated dc Voltage, $T_J = 150^\circ C$)	i_R	5.0 150	µA
Maximum Reverse Recovery Time ($i_F = 1.0 A$, $di/dt = 50 A/\mu s$)	t_{rr}	75	ns

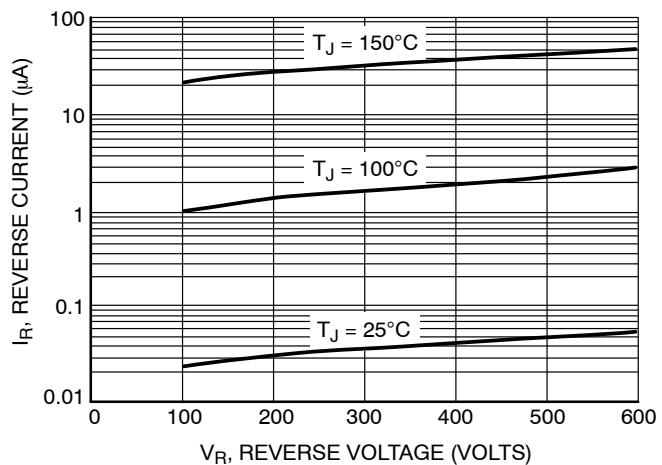


Figure 1. Typical Reverse Current

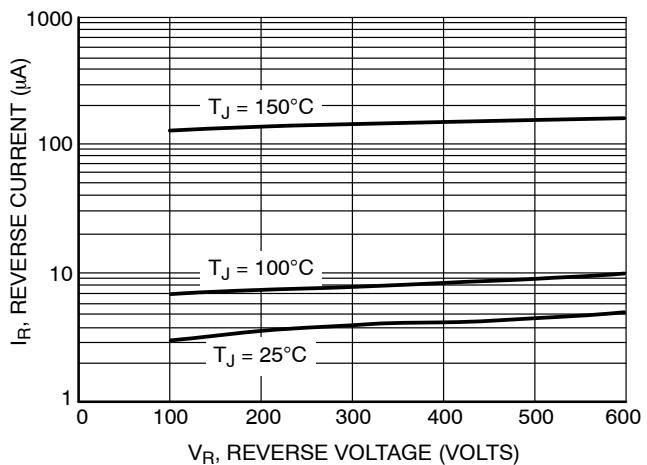


Figure 2. Maximum Reverse Current

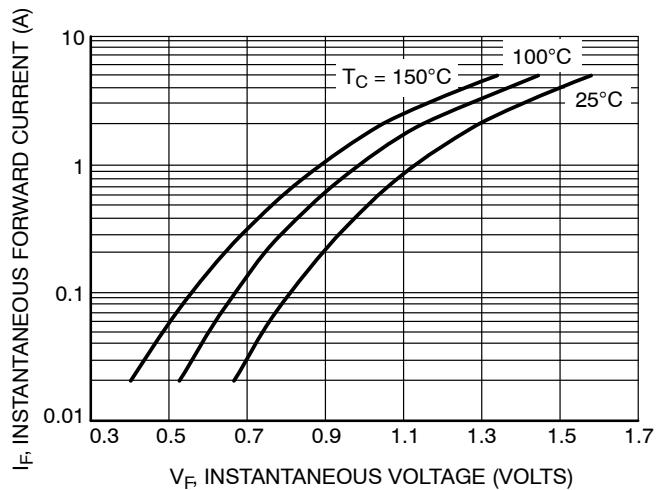


Figure 3. Typical Forward Voltage

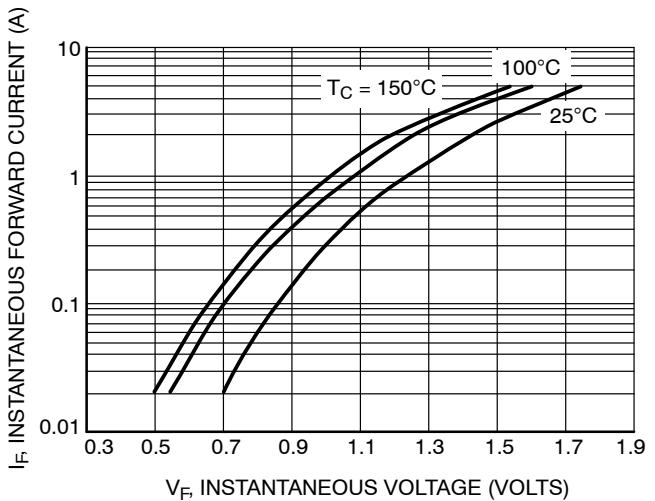
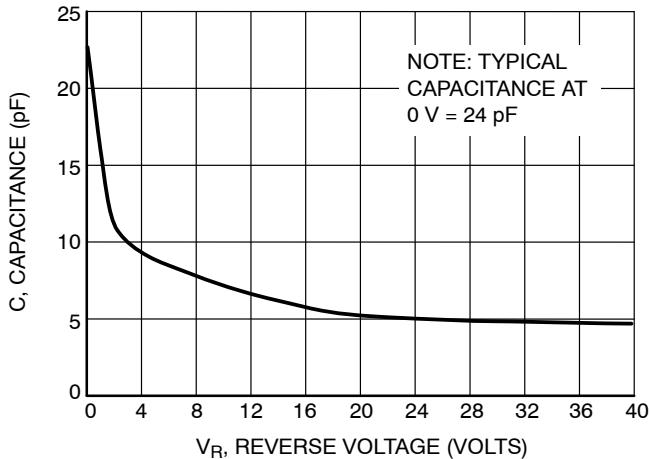
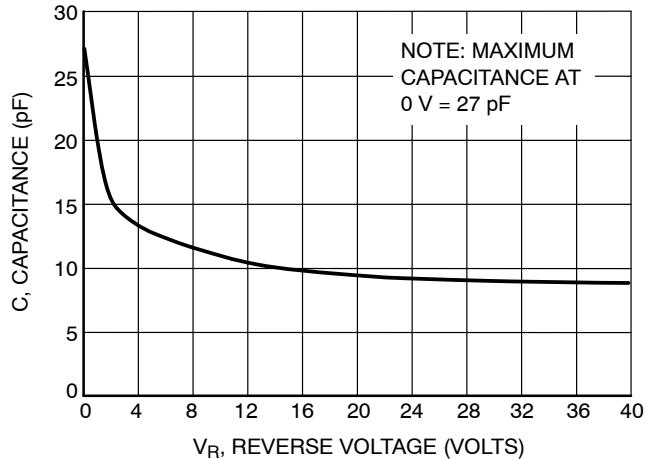
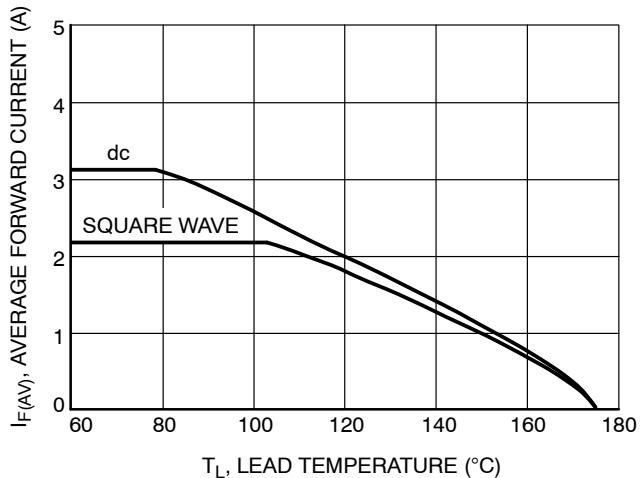
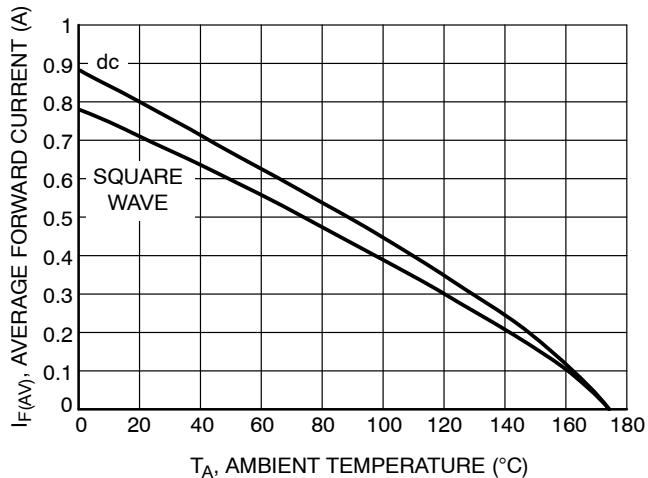
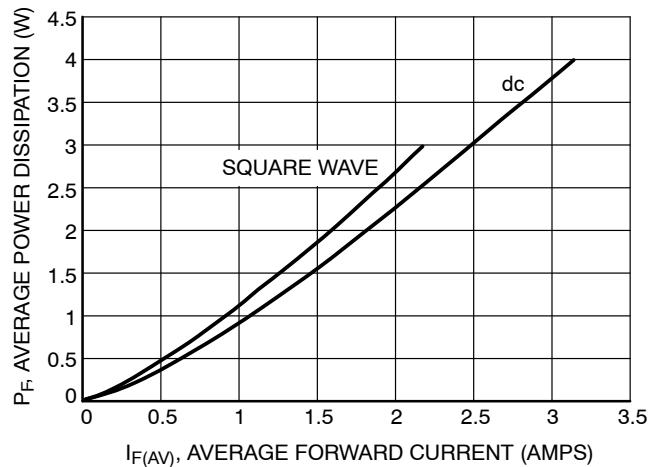


Figure 4. Maximum Forward Voltage


Figure 5. Typical Capacitance

Figure 6. Maximum Capacitance

Figure 7. Current Derating, Lead

Figure 8. Current Derating, Ambient
(FR-4 Board with Minimum Pad)

Figure 9. Power Dissipation